# **Field Stop Trench IGBT** 650 V, 50 A

# FGHL50T65MQD

Field stop 4th generation mid speed IGBT technology and full current rated copak Diode technology.

#### **Features**

- Maximum Junction Temperature: T<sub>J</sub> = 175°C
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage:  $V_{CE(sat)} = 1.45 \text{ V (Typ.)}$  @  $I_C = 50 \text{ A}$
- 100% of the Parts are Tested for I<sub>LM</sub> (Note 2)
- Smooth & Optimized Switching
- Tight Parameter Distribution
- RoHS Compliant

#### **Typical Applications**

- Solar Inverter
- UPS, ESS
- PFC, Converters

#### **MAXIMUM RATINGS**

Parameter	Symbol	Value	Unit	
Collector-to-Emitter Voltage	V <sub>CES</sub>	650	V	
Gate-to-Emitter Voltage		$V_{GES}$	±20	V
Transient Gate-to-Emitter Voltage		$V_{GES}$	±30	V
Collector Current (Note 1)	T <sub>C</sub> = 25°C	Ic	80	Α
	T <sub>C</sub> = 100°C		50	
Pulsed Collector Current (Note 2)		$I_{LM}$	200	Α
Pulsed Collector Current (Note 3)		I <sub>CM</sub>	200	Α
Diode Forward Current (Note 1)	T <sub>C</sub> = 25°C	I <sub>F</sub>	55	Α
	T <sub>C</sub> = 65°C		40	
Pulsed Diode Maximum Forward C	Current	I <sub>FM</sub>	200	Α
Non-Repetitive Forward Surge Cu (Half-Sine Pulse, $t_p$ = 8.3 ms, $T_C$ = (Half-Sine Pulse, $t_p$ = 8.3 ms, $T_C$ =	I <sub>F,SM</sub>	135 120	Α	
Maximum Power Dissipation	um Power Dissipation $T_C = 25^{\circ}C$		268	W
	T <sub>C</sub> = 100°C		134	
Operating Junction and Storage Te Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	
Maximum Lead Temperature for Soldering Purposes (1/8" from case for 5 s)		TL	300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

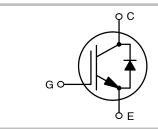
- 1. Value limit by bond wire
- 2.  $V_{CC}$  = 400 V,  $V_{GE}$  = 15 V,  $I_{C}$  = 200 A,  $R_{G}$  = 14  $\Omega$ , Inductive Load, 100% Tested 3. Repetitive rating: Pulse width limited by max. junction temperature

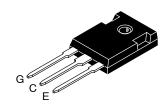


### ON Semiconductor®

#### www.onsemi.com

BV <sub>CES</sub>	V <sub>CE(sat)</sub> TYP	I <sub>C</sub> MAX
650 V	1.45 V	50 A





TO-247 LONG LEADS CASE 340CX

#### MARKING DIAGRAM



&Z = Assembly Plant Code &3 = 3-Digit Date Code

= 2-Digit Lot Traceability Code &K

FGHL50T65MQD = Specific Device Code

#### **ORDERING INFORMATION**

Device	Package	Shipping
FGHL50T65MQD	TO-247-3L	30 Units / Rail

**Table 1. THERMAL CHARACTERISTICS** 

Parameter	Symbol	Value	Unit
Thermal Resistance Junction-to-Case, for IGBT	$R_{\theta JC}$	0.56	°C/W
Thermal Resistance Junction-to-Case, for Diode	$R_{ heta JC}$	1.07	
Thermal Resistance Junction-to-Ambient	$R_{\theta JA}$	40	

Table 2. ELECTRICAL CHARACTERISTICS ( $T_J = 25^{\circ}C$  unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTIC						
Collector-emitter breakdown voltage, gate-emitter short-circuited	$V_{GE} = 0 \text{ V, I}_{C} = 1 \text{ mA}$	BV <sub>CES</sub>	650	-	_	V
Temperature Coefficient of Breakdown Voltage	$V_{GE} = 0 \text{ V, I}_{C} = 1 \text{ mA}$	$\Delta BV_{CES}/\Delta T_{J}$	-	0.6	_	V/°C
Collector-emitter cut-off current, gate-emitter short-circuited	$V_{GE} = 0 \text{ V}, V_{CE} = 650 \text{ V}$	I <sub>CES</sub>	-	-	250	μΑ
Gate leakage current, collector-emitter short-circuited	V <sub>GE</sub> = 20 V, V <sub>CE</sub> = 0 V	I <sub>GES</sub>	-	-	±400	nA
ON CHARACTERISTIC		•			•	•
Gate-emitter threshold voltage	$V_{GE} = V_{CE}$ , $I_C = 50 \text{ mA}$	$V_{GE(th)}$	3.0	4.5	6.0	V
Collector-emitter saturation voltage	V <sub>GE</sub> = 15 V, I <sub>C</sub> = 50 A V <sub>GE</sub> = 15 V, I <sub>C</sub> = 50 A, T <sub>J</sub> = 175°C	V <sub>CE(sat)</sub>	-	1.45 1.77	1.8 -	V
DYNAMIC CHARACTERISTIC		•			•	•
Input capacitance	$V_{CE} = 30 \text{ V}, V_{GE} = 0 \text{ V}, f = 1 \text{ MHz}$	C <sub>ies</sub>	-	3226	_	pF
Output capacitance		C <sub>oes</sub>	-	85	-	1
Reverse transfer capacitance		C <sub>res</sub>	-	10	-	
Gate charge total	$V_{CE}$ = 400 V, $I_{C}$ = 50 A, $V_{GE}$ = 15 V	$Q_g$	_	94	-	nC
Gate-to-Emitter charge		$Q_{ge}$	_	17	-	
Gate-to-Collector charge		$Q_{gc}$	_	22	-	
SWITCHING CHARACTERISTIC, INDI	JCTIVE LOAD					
Turn-on delay time	T <sub>C</sub> = 25°C	t <sub>d(on)</sub>	-	21	-	ns
Rise time	$V_{CC}$ = 400 V, $I_C$ = 25 A $R_G$ = 10 $\Omega$	t <sub>r</sub>	-	15	-	
Turn-off delay time	$V_{GE}$ = 15 V Inductive Load	t <sub>d(off)</sub>	-	128	-	
Fall time		t <sub>f</sub>	-	50	-	
Turn-on switching loss		E <sub>on</sub>	-	0.41	-	mJ
Turn-off switching loss		E <sub>off</sub>	-	0.31	-	
Total switching loss		E <sub>ts</sub>	-	0.72	-	
Turn-on delay time	T <sub>C</sub> = 25°C	t <sub>d(on)</sub>	-	23	-	ns
Rise time	$V_{CC}$ = 400 V, $I_C$ = 50 A $R_G$ = 10 $\Omega$	t <sub>r</sub>	-	34	-	1
Turn-off delay time	V <sub>GE</sub> = 15 V Inductive Load	t <sub>d(off)</sub>	ı	120	-	
Fall time		t <sub>f</sub>	İ	46	_	
Turn-on switching loss		E <sub>on</sub>	ı	1.05	_	mJ
Turn-off switching loss		E <sub>off</sub>	1	0.70	-	
Total switching loss		E <sub>ts</sub>	_	1.75	-	]

Table 2. ELECTRICAL CHARACTERISTICS ( $T_J = 25^{\circ}C$  unless otherwise specified) (continued)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
SWITCHING CHARACTERISTIC, IN	DUCTIVE LOAD			•		•
Turn-on delay time	T <sub>C</sub> = 175°C	t <sub>d(on)</sub>	-	20	_	ns
Rise time	$V_{CC} = 400 \text{ V, } I_{C} = 25 \text{ A}$ $R_{G} = 10 \Omega$	t <sub>r</sub>	-	17	-	
Turn-off delay time	V <sub>GE</sub> = 15 V Inductive Load	t <sub>d(off)</sub>	-	146	-	
Fall time	1	t <sub>f</sub>	-	75	-	
Turn-on switching loss		E <sub>on</sub>	-	0.75	-	mJ
Turn-off switching loss		E <sub>off</sub>	-	0.53	-	
Total switching loss	1	E <sub>ts</sub>	-	1.28	-	
Turn-on delay time	T <sub>C</sub> = 175°C	t <sub>d(on)</sub>	-	22	-	ns
Rise time	$V_{CC}$ = 400 V, $I_{C}$ = 50 A $R_{G}$ = 10 $\Omega$	t <sub>r</sub>	-	36	-	
Turn-off delay time	V <sub>GE</sub> = 15 V Inductive Load	t <sub>d(off)</sub>	-	130	-	
Fall time		t <sub>f</sub>	-	58	-	
Turn-on switching loss		E <sub>on</sub>	-	1.63	-	mJ
Turn-off switching loss		E <sub>off</sub>	-	0.94	-	
Total switching loss		E <sub>ts</sub>	ı	2.57	-	
DIODE CHARACTERISTIC						
Diode Forward Voltage	I <sub>F</sub> = 50 A, T <sub>C</sub> = 25°C I <sub>F</sub> = 50 A, T <sub>C</sub> = 175°C	V <sub>FM</sub>	- -	2.45 2.2	2.75 -	V
Reverse Recovery Energy	$I_F = 50 \text{ A}, \text{ dI}_F/\text{dt} = 200 \text{ A/}\mu\text{s}, \text{ T}_C = 175^{\circ}\text{C}$	E <sub>rec</sub>	-	57	-	μJ
Diode Reverse Recovery Time	$I_F = 50 \text{ A}, \text{ d}I_F/\text{d}t = 200 \text{ A}/\mu\text{s}, T_C = 25^{\circ}\text{C}$ $I_F = 50 \text{ A}, \text{ d}I_F/\text{d}t = 200 \text{ A}/\mu\text{s}, T_C = 175^{\circ}\text{C}$	T <sub>rr</sub>	-	32 202	=	ns
Diode Reverse Recovery Charge	$I_F = 50 \text{ A}, \text{ d}I_F/\text{d}t = 200 \text{ A}/\mu\text{s}, T_C = 25^{\circ}\text{C}$ $I_F = 50 \text{ A}, \text{ d}I_F/\text{d}t = 200 \text{ A}/\mu\text{s}, T_C = 175^{\circ}\text{C}$	Q <sub>rr</sub>	-	46 814	_	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### **TYPICAL CHARACTERISTICS**

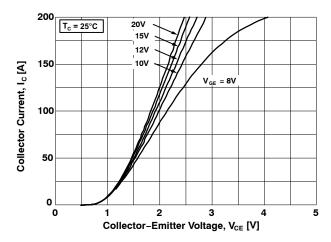


Figure 1. Typical Output Characteristics  $(T_J = 25^{\circ}C)$ 

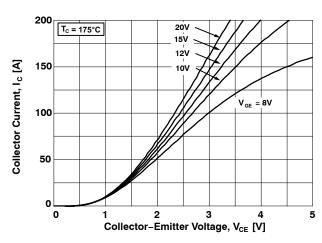


Figure 2. Typical Output Characteristics  $(T_J = 175^{\circ}C)$ 

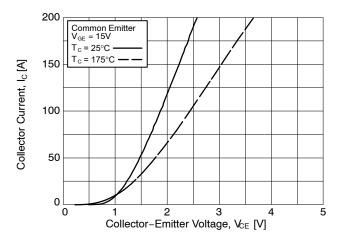


Figure 3. Typical Saturation Voltage Characteristics

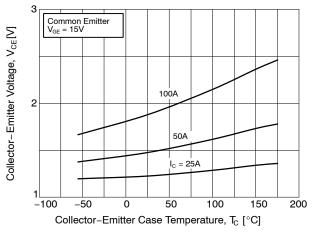


Figure 4. Saturation Voltage vs. Case Temperature at Variant Current Level

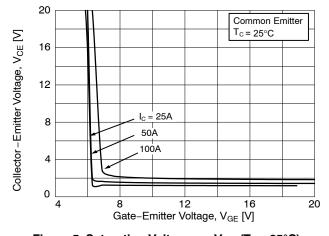


Figure 5. Saturation Voltage vs.  $V_{GE}$  (T<sub>J</sub> = 25°C)

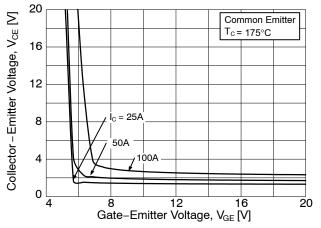


Figure 6. Saturation Voltage vs. V<sub>GE</sub> (T<sub>J</sub> = 175°C)

## TYPICAL CHARACTERISTICS (continued)

Gate - Emitter Voltage, VGE [V]

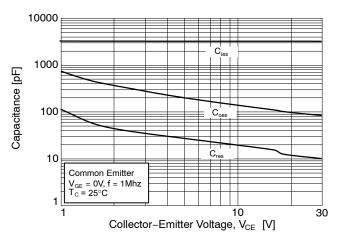


Figure 7. Capacitance Characteristics

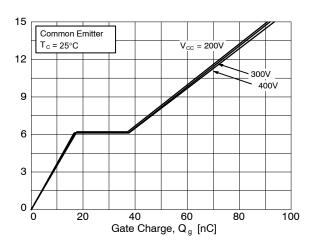


Figure 8. Gate Charge Characteristics

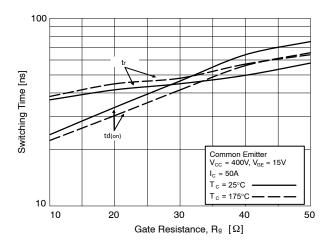


Figure 9. Turn-On Characteristics vs. Gate Resistance

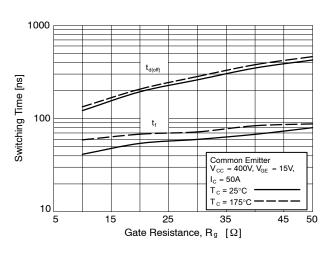


Figure 10. Turn-Off Characteristics vs. Gate Resistance

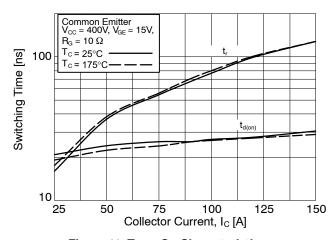


Figure 11. Turn-On Characteristics vs. Collector Current

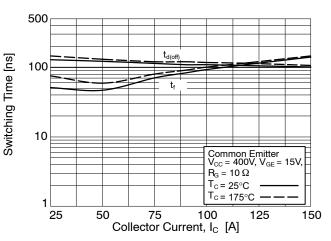


Figure 12. Turn-Off Characteristics vs. Collector Current

#### TYPICAL CHARACTERISTICS (continued)

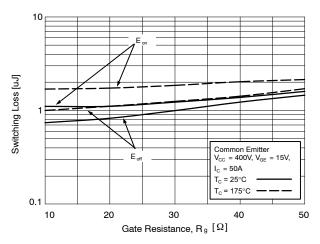


Figure 13. Switching Loss vs. Gate Resistance

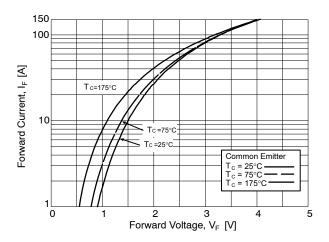


Figure 15. Forward Characteristics

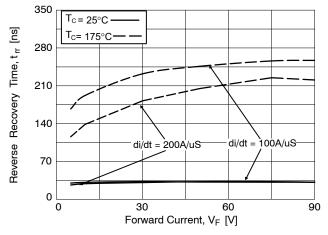


Figure 17. Reverse Recovery Time

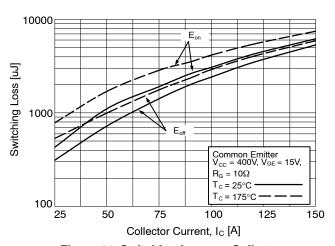
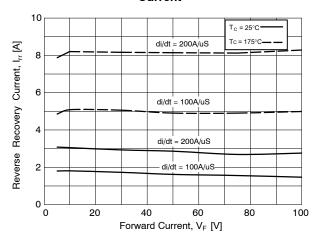


Figure 14. Switching Loss vs. Collector Current



**Figure 16. Reverse Recovery Current** 

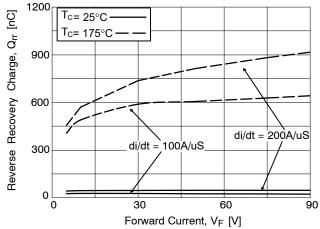


Figure 18. Stored Charge

## TYPICAL CHARACTERISTICS (continued)

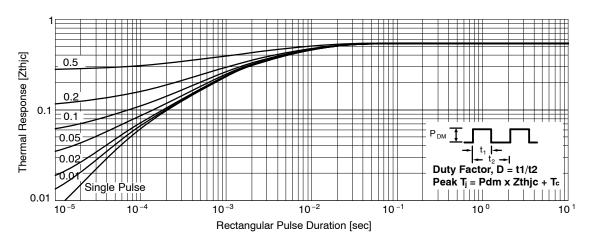


Figure 19. Transient Thermal Impedance of IGBT

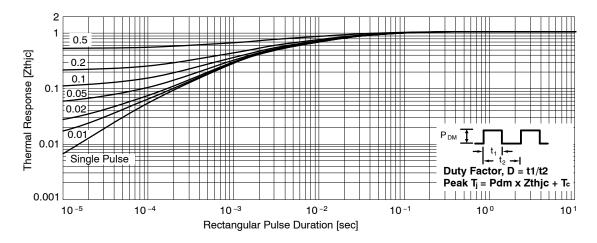
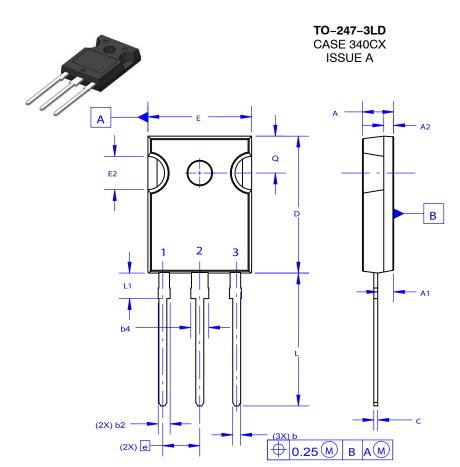


Figure 20. Transient Thermal Impedance of Diode

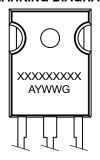
**DATE 06 JUL 2020** 



NOTES: UNLESS OTHERWISE SPECIFIED.

- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DRAWING CONFORMS TO ASME Y14.5 2009.
- D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

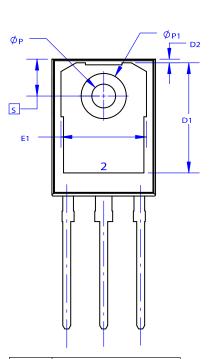
# GENERIC MARKING DIAGRAM\*



XXXXX = Specific Device Code A = Assembly Location

Y = Year WW = Work Week G = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " •", may or may not be present. Some products may not follow the Generic Marking.



DIM	MILLIMETERS				
DIM	MIN	NOM	MAX		
Α	4.58	4.70	4.82		
<b>A</b> 1	2.20	2.40	2.60		
A2	1.40	1.50	1.60		
D	20.32	20.57	20.82		
E	15.37	15.62	15.87		
E2	4.96	5.08	5.20		
е	~	5.56	~		
L	19.75	20.00	20.25		
L1	3.69	3.81	3.93		
ØΡ	3.51	3.58	3.65		
Q	5.34	5.46	5.58		
S	5.34	5.46	5.58		
b	1.17	1.26	1.35		
b2	1.53	1.65	1.77		
b4	2.42	2.54	2.66		
С	0.51	0.61	0.71		
D1	13.08	~	~		
D2	0.51	0.93	1.35		
E1	12.81	~	~		
ØP1	6.60	6.80	7.00		

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AFGY160T65SPD-B4 IGW30N60TP IGW40N60TP IGW50N60TP IHW30N65R5 IKFW40N60DH3E IKP15N65H5 IKQ100N60T

IKQ120N60T IKW30N65WR5 IKW75N60H3 IKZ50N65NH5 IKZ75N65NH5 FGD3040G2-F085C FGH4L50T65SQD FGHL40T65MQDT

FGHL50T65MQD FGHL50T65MQDTL4 FGHL75T65LQDT FGHL75T65MQD FGHL75T65MQDT FGHL75T65MQDTL4

FGY75T120SWD EL3120S1(TA)(SAS)-V IHW15N120E1 IKQ75N120CS6 IKW50N65WR5 SL15T65FK KGF50N65KDF-U/H

IHFW40N65R5S IKW08N120CS7XKSA1 IKQ75N120CH3 IHW30N160R5 SGM100HF12A1TFD CRG50T60AK3SD CRG40T60AN3S